### **DISCRETE SEMICONDUCTORS**

# DATA SHEET

### **BST80**

# N-channel enhancement mode vertical D-MOS transistor

Product specification Supersedes data of April 1995 File under Discrete Semiconductors, SC13b 1997 Jun 20





**BST80** 

#### **FEATURES**

- Low drain-source on-state resistance
- Direct interface to C-MOS, TTL, etc.
- High-speed switching
- No secondary breakdown.

### **APPLICATIONS**

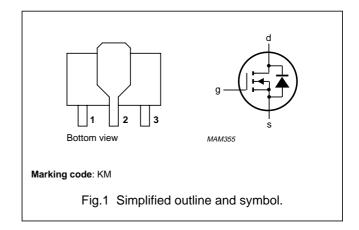
- · Thin and thick film circuits
- Relay, high-speed and line transformer drivers.

#### **DESCRIPTION**

N-channel enhancement mode vertical D-MOS transistor in a SOT89 package.

#### **PINNING - SOT89**

PIN	SYMBOL	DESCRIPTION
1	S	source
2	d	drain
3	g	gate



### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	PARAMETER CONDITIONS		MAX.	UNIT
V <sub>DS</sub>	drain-source voltage (DC)		_	80	V
$V_{GSO}$	gate-source voltage (DC)	open drain	_	±20	V
$I_D$	drain current (DC)		_	500	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	_	1	W
R <sub>DSon</sub>	drain-source on-state resistance	$I_D = 500 \text{ mA}; V_{GS} = 10 \text{ V}$	2	3	Ω
y <sub>fs</sub>	forward transfer admittance	I <sub>D</sub> = 500 mA; V <sub>DS</sub> = 15 V	300	_	mS

### N-channel enhancement mode vertical D-MOS transistor

BST80

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>DS</sub>	drain-source voltage (DC)		_	80	V
$V_{GSO}$	gate-source voltage (DC)	open drain	_	±20	V
I <sub>D</sub>	drain current (DC)		_	500	mA
I <sub>DM</sub>	peak drain current		_	1	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	1	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	125	K/W

#### Note to the Limiting values and Thermal characteristics

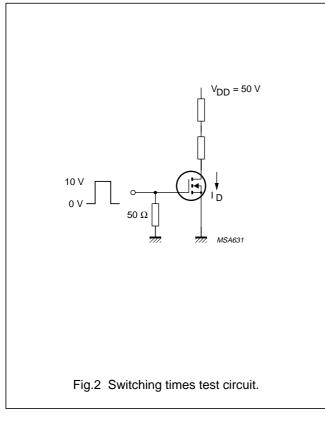
1. Device mounted on a ceramic substrate; area 2.5 cm<sup>2</sup>; thickness 0.7 mm.

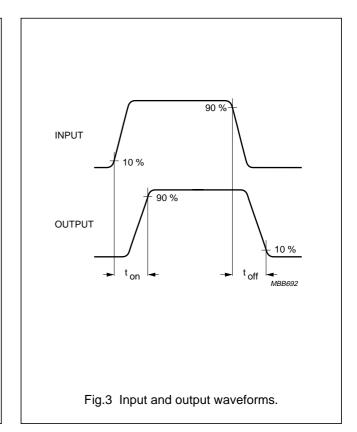
#### **CHARACTERISTICS**

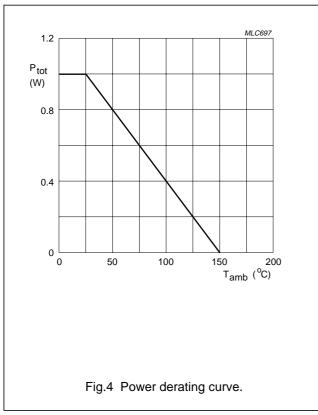
 $T_j$  = 25  $^{\circ}C$  unless otherwise specified.

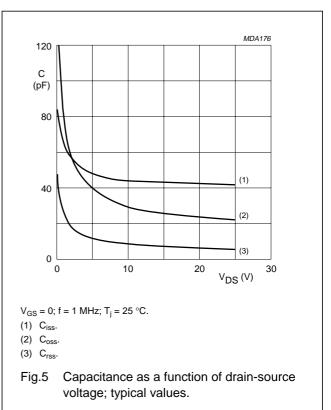
SYMBOL	PARAMETER	PARAMETER CONDITIONS		TYP.	MAX.	UNIT
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$V_{GS} = 0$ ; $I_D = 10 \mu A$	80	_	_	٧
V <sub>GSth</sub>	gate-source threshold voltage	$V_{DS} = V_{GS}$ ; $I_D = 1 \text{ mA}$	1.5	_	3.5	V
I <sub>DSS</sub>	drain-source leakage current	V <sub>DS</sub> = 60 V; V <sub>GS</sub> = 0	_	_	1	μΑ
$I_{GSS}$	gate leakage current	$V_{DS} = 0; V_{GS} = \pm 20 \text{ V}$	_	_	±100	nA
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 500 mA	_	2	3	Ω
y <sub>fs</sub>	forward transfer admittance	$I_D = 500 \text{ mA}; V_{DS} = 15 \text{ V}$	_	300	_	mS
C <sub>iss</sub>	input capacitance	$V_{DS} = 10 \text{ V}; V_{GS} = 0; f = 1 \text{ MHz}$	_	45	60	pF
Coss	output capacitance	$V_{DS} = 10 \text{ V}; V_{GS} = 0; f = 1 \text{ MHz}$	-	30	45	pF
C <sub>rss</sub>	reverse transfer capacitance	$V_{DS} = 10 \text{ V}; V_{GS} = 0; f = 1 \text{ MHz}$	_	8	12	pF
Switching to	imes (see Figs 2 and 3)		-	-	-	
t <sub>on</sub>	turn-on time	$V_{GS} = 0$ to 10 V; $V_{DD} = 50$ V; $I_D = 500$ mA	_	_	10	ns
t <sub>off</sub>	turn-off time	$V_{GS} = 10 \text{ to } 0 \text{ V}; V_{DD} = 50 \text{ V};$ $I_D = 500 \text{ mA}$	_	_	15	ns

BST80

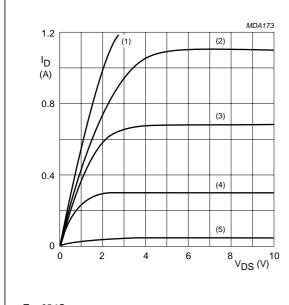








BST80



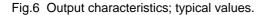
 $T_j = 25 \, ^{\circ}C$ .

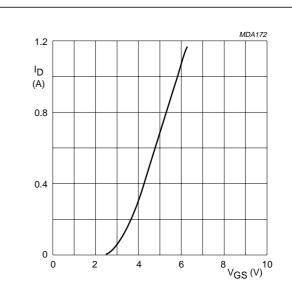
(1)  $V_{GS} = 10 \text{ V}.$ 

(2)  $V_{GS} = 6 V$ .

(4)  $V_{GS} = 4 V$ .

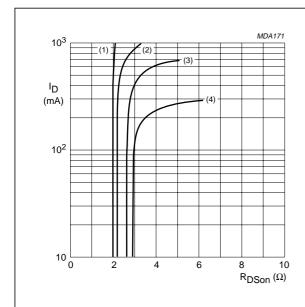
(3)  $V_{GS} = 5 \text{ V}$ . (5)  $V_{GS} = 3 \text{ V}$ .





 $V_{DS}$  = 10 V;  $T_j$  = 25 °C.

Fig.7 Transfer characteristic; typical values.



 $T_j = 25 \, ^{\circ}C$ .

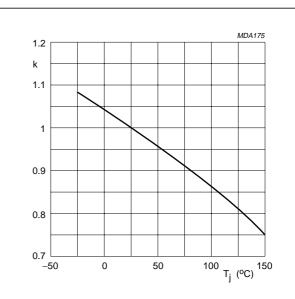
(1)  $V_{GS} = 10 \text{ V}.$ 

(3)  $V_{GS} = 5 \text{ V}.$ 

(2)  $V_{GS} = 6 V$ .

(4)  $V_{GS} = 4 V$ .

Fig.8 Drain current as a function of drain-source on-state resistance; typical values.



 $k \, = \, \frac{V_{GSth} \; at \; T_j}{V_{GSth} \; at \; 25^{\circ}C}$ 

V<sub>GSth</sub> at 1 mA.

Fig.9 Temperature coefficient of gate-source threshold voltage; typical values.

### N-channel enhancement mode vertical D-MOS transistor

BST80

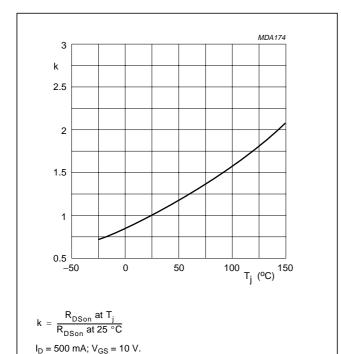


Fig.10 Temperature coefficient of drain-source on-state resistance; typical values.

1997 Jun 20

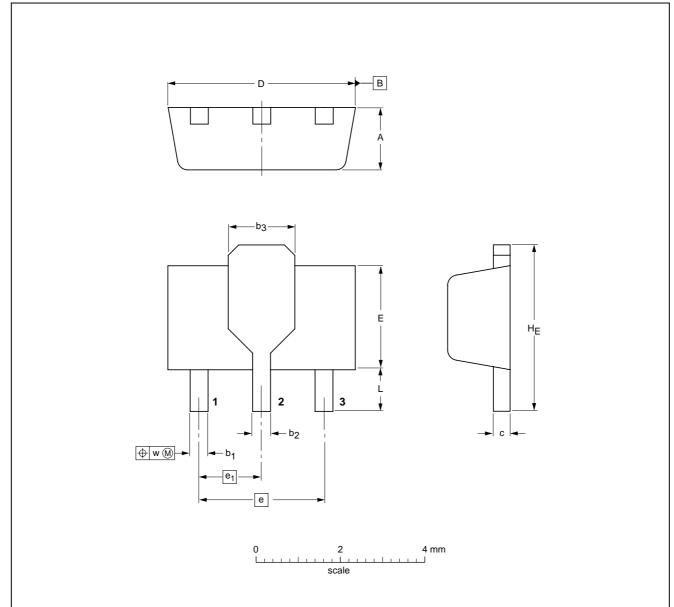
6

BST80

### **PACKAGE OUTLINE**

Plastic surface mounted package; drain pad for good heat transfer; 3 leads

**SOT89** 



### **DIMENSIONS** (mm are the original dimensions)

UNIT	A	b <sub>1</sub>	b <sub>2</sub>	b <sub>3</sub>	С	D	E	е	e <sub>1</sub>	HE	L min.	w
mm	1.6 1.4	0.48 0.35	0.53 0.40	1.8 1.4	0.44 0.37	4.6 4.4	2.6 2.4	3.0	1.5	4.25 3.75	0.8	0.13

OUTLINE		REFERENCES			EUROPEAN ISSUE DAT		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT89						97-02-28	

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**BST80** 

#### **DEFINITIONS**

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

#### LIFE SUPPORT APPLICATIONS

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BST80

**NOTES** 

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BST80

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SCA54

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